

Single Zener diodes in a SOD123F package Rev. 3 — 7 December 2010

Product data sheet

Unit V

mW

mW

830

1. **Product profile**

1.1 General description

General-purpose Zener diodes in a SOD123F small and flat lead Surface-Mounted Device (SMD) plastic package.

1.2 Features and benefits

- Total power dissipation: ≤ 830 mW
- Wide working voltage range: nominal 2.4 V to 75 V (E24 range)
- Small plastic package suitable for surface-mounted design

1.3 Applications

General regulation functions

1.4 Quick reference data

| Table 1. | Quick reference data | | | | |
|------------------|-------------------------|------------------------------|--------------|-----|-----|
| Symbol | Parameter | Conditions | Min | Тур | Max |
| V _F | forward voltage | I _F = 10 mA | <u>[1]</u> _ | - | 0.9 |
| P _{tot} | total power dissipation | $T_{amb} \le 25 \ ^{\circ}C$ | [2] _ | - | 375 |

[1] Pulse test: $t_p \le 300 \ \mu s$; $\delta \le 0.02$.

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

Pinning information 2.

| Pin | Description | Simplified outline | Graphic symbol |
|-----|-------------|--------------------|----------------|
| 1 | cathode | [1] | |
| 2 | anode | 1 2 | 1 <u> </u> |

[1] The marking bar indicates the cathode.



- Low differential resistance
- AEC-Q101 qualified

[3] _

-

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3. Ordering information

| Table 3. Ordering | information | | | | | |
|---|-------------|--|---------|--|--|--|
| Type number | Package | | | | | |
| | Name | Description | Version | | | |
| BZT52H-B2V4 to BZT52H-C75 ^[1] | - | plastic surface-mounted package; 2 leads | SOD123F | | | |

[1] The series consists of 74 types with nominal working voltages from 2.4 V to 75 V.

4. Marking

| Table 4. Mark | ing codes | | | | | | |
|---------------|-----------------|-------------|-----------------|-------------|-----------------|-------------|-----------------|
| Type number | Marking code | Type number | Marking code | Type number | Marking code | Type number | Marking code |
| BZT52H-B2V4 | DC | BZT52H-B15 | DX | BZT52H-C2V4 | B3 | BZT52H-C15 | BN |
| BZT52H-B2V7 | DD | BZT52H-B16 | DY | BZT52H-C2V7 | B4 | BZT52H-C16 | BP |
| BZT52H-B3V0 | DE | BZT52H-B18 | DZ | BZT52H-C3V0 | B5 | BZT52H-C18 | BQ |
| BZT52H-B3V3 | DF | BZT52H-B20 | E1 | BZT52H-C3V3 | B6 | BZT52H-C20 | BR |
| BZT52H-B3V6 | DG | BZT52H-B22 | E2 | BZT52H-C3V6 | B7 | BZT52H-C22 | BS |
| BZT52H-B3V9 | DH | BZT52H-B24 | E3 | BZT52H-C3V9 | B8 | BZT52H-C24 | BT |
| BZT52H-B4V3 | DJ | BZT52H-B27 | E4 | BZT52H-C4V3 | B9 | BZT52H-C27 | BU |
| BZT52H-B4V7 | DK | BZT52H-B30 | E5 | BZT52H-C4V7 | BA | BZT52H-C30 | BV |
| BZT52H-B5V1 | DL | BZT52H-B33 | E6 | BZT52H-C5V1 | BB | BZT52H-C33 | BW |
| BZT52H-B5V6 | DM | BZT52H-B36 | E7 | BZT52H-C5V6 | BC | BZT52H-C36 | BX |
| BZT52H-B6V2 | DN | BZT52H-B39 | E8 | BZT52H-C6V2 | BD | BZT52H-C39 | BY |
| BZT52H-B6V8 | DP | BZT52H-B43 | E9 | BZT52H-C6V8 | BE | BZT52H-C43 | BZ |
| BZT52H-B7V5 | DQ | BZT52H-B47 | EA | BZT52H-C7V5 | BF | BZT52H-C47 | C1 |
| BZT52H-B8V2 | DR | BZT52H-B51 | EB | BZT52H-C8V2 | BG | BZT52H-C51 | C2 |
| BZT52H-B9V1 | DS | BZT52H-B56 | EC | BZT52H-C9V1 | BH | BZT52H-C56 | C3 |
| BZT52H-B10 | DT | BZT52H-B62 | ED | BZT52H-C10 | BJ | BZT52H-C62 | C4 |
| BZT52H-B11 | DU | BZT52H-B68 | EE | BZT52H-C11 | BK | BZT52H-C68 | C5 |
| BZT52H-B12 | DV | BZT52H-B75 | EF | BZT52H-C12 | BL | BZT52H-C75 | C6 |
| BZT52H-B13 | DW | - | - | BZT52H-C13 | BM | - | - |

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5. Limiting values

| Table 5. In accorda | Limiting values ance with the Absolute Maxir | num Rating System (IE | C 60134). | | |
|------------------------|---|-------------------------------|--------------|--|------|
| Symbol | Parameter | Conditions | Min | Мах | Unit |
| I _F | forward current | | - | 250 | mA |
| I _{ZSM} | non-repetitive peak reverse current | | - | see <u>Table 8,9</u> and <u>10</u> | |
| P _{ZSM} | non-repetitive peak reverse power dissipation | | <u>[1]</u> _ | 40 | W |
| P _{tot} | total power dissipation | $T_{amb} \leq 25 \ ^{\circ}C$ | [2] - | 375 | mW |
| | | | <u>[3]</u> _ | 830 | mW |
| Tj | junction temperature | | - | 150 | °C |
| T _{amb} | ambient temperature | | -65 | +150 | °C |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| [1] + _ 10 | 0 us: square ways: $T_{\rm r} = 25 ^{\circ}{\rm C}$ r | vrier to ourge | | | |

[1] $t_p = 100 \ \mu s$; square wave; $T_j = 25 \ ^\circ C$ prior to surge.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

6. Thermal characteristics

| Table 6. | Thermal characteristics | | | | | | | | | | |
|-----------------------|--|-------------|--------------|-----|-----|------|--|--|--|--|--|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit | | | | | |
| R _{th(j-a)} | thermal resistance from | in free air | <u>[1]</u> _ | - | 330 | K/W | | | | | |
| | junction to ambient | | [2] _ | - | 150 | K/W | | | | | |
| R _{th(j-sp)} | thermal resistance from junction to solder point | | <u>[3]</u> | - | 70 | K/W | | | | | |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

[3] Soldering point of cathode tab.

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7. Characteristics

| Table 7. | Characteristics | |
|------------------------|-----------------------------|--|
| $T_i = 25 \ ^{\circ}C$ | unless otherwise specified. | |

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit | | | | |
|----------------|-----------------|------------------------|--------------|-----|-----|------|--|--|--|--|
| V _F | forward voltage | I _F = 10 mA | <u>[1]</u> _ | - | 0.9 | V | | | | |

[1] Pulse test: $t_p \le 300 \ \mu s$; $\delta \le 0.02$.

Table 8. Characteristics per type; BZT52H-B2V4 to BZT52H-C24

 $T_i = 25 \ ^{\circ}C$ unless otherwise specified.

| BZT52H Sel -xxx | | Worki voltag V _Z (V) I _Z = 5 | je ; | Maximum resistance | differential r _{dif} (Ω) | Revers current | e t I _R (μΑ) | Tempe coeffic S _Z (m) I _Z = 5 (| //K); | Diode capacitance C _d (pF) ^[1] | Non-repetitive peak reverse current I _{ZSM} (A) ^[2] |
|--------------------|---|---|---------|-----------------------|--------------------------------------|-------------------|----------------------------|--|-------|--|--|
| | | Min | Max | I _Z = 1 mA | I _Z = 5 mA | Max | V _R (V) | Min | Max | Max | Max |
| 2V4 | В | 2.35 | 2.45 | 400 | 85 | 50 | 1 | -3.5 | 0.0 | 450 | 6.0 |
| | С | 2.2 | 2.6 | | | | | | | | |
| 2V7 | В | 2.65 | 2.75 | 500 | 83 | 20 | 1 | -3.5 | 0.0 | 450 | 6.0 |
| | С | 2.5 | 2.9 | | | | | | | | |
| 3V0 | В | 2.94 | 3.06 | 500 | 95 | 10 | 1 | -3.5 | 0.0 | 450 | 6.0 |
| | С | 2.8 | 3.2 | | | | | | | | |
| 3V3 | В | 3.23 | 3.37 | 500 | 95 | 5 | 1 | -3.5 | 0.0 | 450 | 6.0 |
| | С | 3.1 | 3.5 | | | | | | | | |
| 3V6 | В | 3.53 | 3.67 | 500 | 95 | 5 | 1 | -3.5 | 0.0 | 450 | 6.0 |
| | С | 3.4 | 3.8 | | | | | | | | |
| 3V9 | В | 3.82 | 3.98 | 500 | 95 | 3 | 1 | -3.5 | 0.0 | 450 | 6.0 |
| | С | 3.7 | 4.1 | | | | | | | | |
| 4V3 | В | 4.21 | 4.39 | 500 | 95 | 3 | 1 | -3.5 | 0.0 | 450 | 6.0 |
| | С | 4.0 | 4.6 | | | | | | | | |
| 4V7 | В | 4.61 | 4.79 | 500 | 78 | 3 | 2 | -3.5 | 0.2 | 300 | 6.0 |
| | С | 4.4 | 5.0 | | | | | | | | |
| 5V1 | В | 5.0 | 5.2 | 480 | 60 | 2 | 2 | -2.7 | 1.2 | 300 | 6.0 |
| | С | 4.8 | 5.4 | | | | | | | | |
| 5V6 | В | 5.49 | 5.71 | 400 | 40 | 1 | 2 | -2.0 | 2.5 | 300 | 6.0 |
| | С | 5.2 | 6.0 | | | | | | | | |
| 6V2 | В | 6.08 | 6.32 | 150 | 10 | 3 | 4 | 0.4 | 3.7 | 200 | 6.0 |
| | С | 5.8 | 6.6 | | | | | | | | |
| 6V8 | В | 6.66 | 6.94 | 80 | 8 | 2 | 4 | 1.2 | 4.5 | 200 | 6.0 |
| | С | 6.4 | 7.2 | | | | | | | | |
| 7V5 | В | 7.35 | 7.65 | 80 | 10 | 1 | 5 | 2.5 | 5.3 | 150 | 4.0 |
| | С | 7.0 | 7.9 | | | | | | | | |
| 3V2 | В | 8.04 | 8.36 | 80 | 10 | 0.7 | 5 | 3.2 | 6.2 | 150 | 4.0 |
| | С | 7.7 | 8.7 | | | | | | | | |

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| BZT52H Sel -xxx | | el Working voltage V _Z (V); I _Z = 5 mA | | | Maximum differential resistance r _{dif} (Ω) | | se t I _R (μΑ) | Tempo coeffi S _Z (m ¹ I _Z = 5 | V/K); | Diode capacitance C _d (pF) ^[1] | Non-repetitive peak reverse current I _{ZSM} (A) ^[2] |
|--------------------|---|---|--------------|-----------------------|---|------|-----------------------------|---|-------|--|--|
| | | Min | Max | I _Z = 1 mA | I _Z = 5 mA | Max | V _R (V) | Min | Max | Max | Max |
| 9V1 | В | 8.92 | 9.28 | 100 | 10 | 0.5 | 6 | 3.8 | 7.0 | 150 | 3.0 |
| | С | 8.5 | 9.6 | | | | | | | | |
| 10 | В | 9.8 | 10.2 | 70 | 10 | 0.2 | 7 | 4.5 | 8.0 | 90 | 3.0 |
| | С | 9.4 | 10.6 | | | | | | | | |
| 11 | В | 10.8 | 11.2 | 70 | 10 | 0.1 | 8 | 5.4 | 9.0 | 85 | 2.5 |
| | С | 10.4 | 11.6 | | | | | | | | |
| 12 | В | 11.8 | 12.2 | 90 | 10 | 0.1 | 8 | 6.0 | 10.0 | 85 | 2.5 |
| | С | 11.4 | 12.7 | | | | | | | | |
| 13 | В | 12.7 | 13.3 | 110 | 10 | 0.1 | 8 | 7.0 | 11.0 | 80 | 2.5 |
| | С | 12.4 | 14.1 | | | | | | | | |
| 15 | В | 14.7 | 4.7 15.3 110 | 110 | 15 | 0.05 | 10.5 | 9.2 | 13.0 | 75 | 2.0 |
| | С | 13.8 | 15.6 | | | | | | | | |
| 16 | В | 15.7 | 16.3 | 170 | 20 | 0.05 | 11.2 | 10.4 | 14.0 | 75 | 1.5 |
| | С | 15.3 | 17.1 | | | | | | | | |
| 18 | В | 17.6 | 18.4 | 170 | 20 | 0.05 | 12.6 | 12.4 | 16.0 | 70 | 1.5 |
| | С | 16.8 | 19.1 | | | | | | | | |
| 20 | В | 19.6 | 20.4 | 220 | 20 | 0.05 | 14 | 14.4 | 18.0 | 60 | 1.5 |
| | С | 18.8 | 21.2 | | | | | | | | |
| 22 | В | 21.6 | 22.4 | 220 | 25 | 0.05 | 15.4 | 16.4 | 20.0 | 60 | 1.25 |
| | С | 20.8 | 23.3 | | | | | | | | |
| 24 | В | 23.5 | 24.5 | 220 | 30 | 0.05 | 16.8 | 18.4 | 22.0 | 55 | 1.25 |
| | С | 22.8 | 25.6 | | | | | | | | |

Table 8. Characteristics per type; BZT52H-B2V4 to BZT52H-C24 ...continued

[1] $f = 1 \text{ MHz}; V_R = 0 \text{ V}.$

[2] $t_p = 100 \ \mu s; T_{amb} = 25 \ ^{\circ}C.$

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| BZT52H Sel -xxx | | el Working voltage V _Z (V); I _Z = 2 mA | | Maximum differential resistance r _{dif} (Ω) | | current I _R (μΑ) | | Temperature coefficient S _Z (mV/K); I _Z = 5 mA | | Diode capacitance C _d (pF) <mark>[1]</mark> | Non-repetitive peak reverse current I _{ZSM} (A) ^[2] |
|--------------------|---|---|------|---|-----------------------|-----------------------------|--------------------|---|-----------|--|--|
| | | Min | Мах | I _Z = 1 mA | I _Z = 5 mA | Мах | V _R (V) | Min | Max | Max | Max |
| 27 | В | 26.5 | 27.5 | 250 | 40 | 0.05 | 18.9 | 21.4 | 25.3 | 50 | 1.0 |
| | С | 25.1 | 28.9 | | | | | | | | |
| 30 | В | 29.4 | 30.6 | 250 | 40 | 0.05 | 21 | 24.4 | 29.4 | 50 | 1.0 |
| | С | 28.0 | 32.0 | | | | | | | | |
| 33 | В | 32.3 | 33.7 | 250 | 40 | 0.05 | 23.1 | 27.4 | 33.4 | 45 | 0.9 |
| | С | 31.0 | 35.0 | | | | | | | | |
| 36 | В | 35.3 | 36.7 | 250 | 60 | 0.05 | 25.2 | 30.4 | 37.4 | 45 | 0.8 |
| | С | 34.0 | 38.0 | | | | | | | | |
| 39 | В | 38.2 | 39.8 | 300 | 75 | 0.05 | 27.3 | 33.4 | 33.4 41.2 | 45 | 0.7 |
| | С | 37.0 | 41.0 | | | | | | | | |
| 43 | В | 42.1 | 43.9 | 325 | 80 | 0.05 | 30.1 | 37.6 | 46.6 | 40 | 0.6 |
| | С | 40.0 | 46.0 | | | | | | | | |
| 47 | В | 46.1 | 47.9 | 325 | 90 | 0.05 | 32.9 | 42.0 | 51.8 | 40 | 0.5 |
| | С | 44.0 | 50.0 | | | | | | | | |
| 51 | В | 50.0 | 52.0 | 350 | 100 | 0.05 | 35.7 | 46.6 | 46.6 57.2 | 40 | 0.4 |
| | С | 48.0 | 54.0 | | | | | | | | |

Table 9.Characteristics per type; BZT52H-B27 to BZT52H-C51 $T_i = 25 \ ^{\circ}C$ unless otherwise specified.

[1] $f = 1 \text{ MHz}; V_R = 0 \text{ V}.$

[2] $t_p = 100 \ \mu s; T_{amb} = 25 \ ^{\circ}C.$

Table 10. Characteristics per type; BZT52H-B56 to BZT52H-C75

 $T_i = 25 \ ^{\circ}C$ unless otherwise specified.

| BZT52H Sel -xxx | | Working voltage V _Z (V); I _Z = 2 mA | | Maximum differential resistance r _{dif} (Ω) | | | Reverse current I _R (μΑ) | | erature cient //K); mA | Diode capacitance C _d (pF) ^[1] | Non-repetitive peak reverse current I _{ZSM} (A) ^[2] |
|--------------------|---|--|------|---|-----------------------|-----------|--|----------|---------------------------------|--|--|
| | | Min | Max | I _Z = 0.5 mA | I _Z = 2 mA | Max | V _R (V) | Min | Max | Max | Мах |
| 56 | В | 54.9 | 57.1 | 375 | 120 | 0.05 | 39.2 | 52.2 | 63.8 | 40 | 0.3 |
| | С | 52.0 | 60.0 | | | | | | | | |
| 62 | В | 60.8 | 63.2 | 400 | 140 | 40 0.05 4 | 43.4 | 58.8 | 71.6 | 35 | 0.3 |
| | С | 58.0 | 66.0 | | | | | | | | |
| 68 | В | 66.6 | 69.4 | 400 | 160 | 0.05 | 47.6 | 65.6 | 79.8 | 35 | 0.25 |
| | С | 64.0 | 72.0 | | | | | | | | |
| 75 | В | 73.5 | 76.5 | 400 175 | 0.05 | 52.5 | 73.4 | 3.4 88.6 | 35 | 0.20 | |
| | С | 70.0 | 79.0 | | | | | | | | |

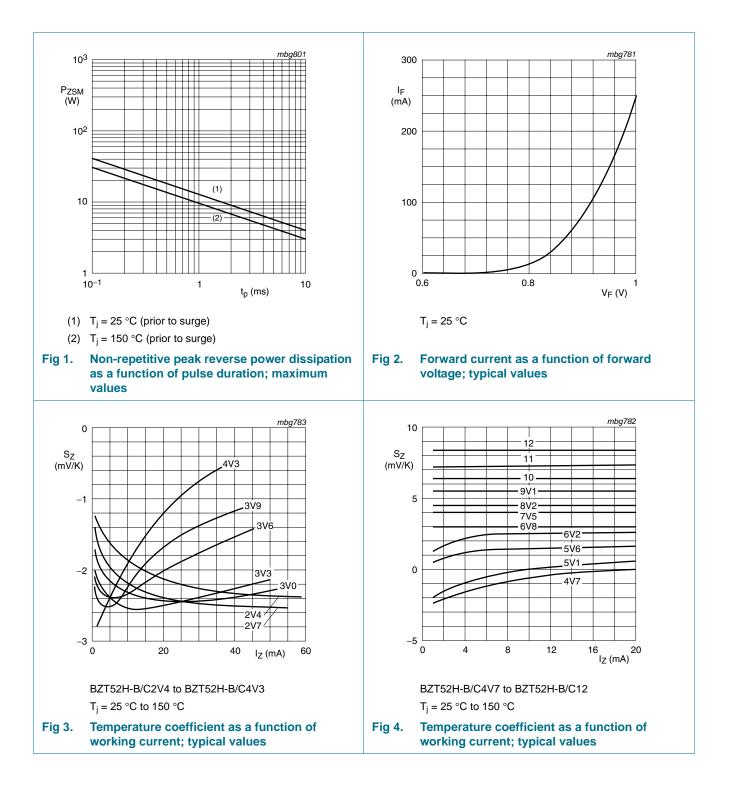
[1] $f = 1 \text{ MHz}; V_R = 0 \text{ V}.$

[2] $t_p = 100 \ \mu s; T_{amb} = 25 \ ^{\circ}C.$

NXP Semiconductors

BZT52H series

Single Zener diodes in a SOD123F package



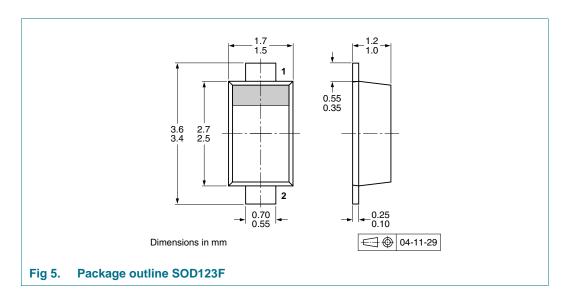
Single Zener diodes in a SOD123F package

8. Test information

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

9. Package outline



10. Packing information

Table 11. Packing methods

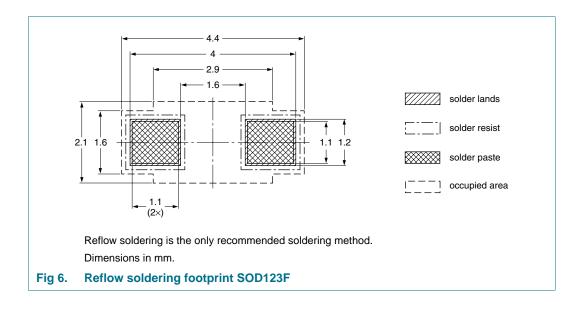
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

| Type number | Package | Description | Packing quantity | |
|------------------------------|---------|--------------------------------|------------------|-------|
| | | | 3000 | 10000 |
| BZT52H-B2V4 to BZT52H-C75 | SOD123F | 4 mm pitch, 8 mm tape and reel | -115 | -135 |

[1] For further information and the availability of packing methods, see Section 14.

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11. Soldering



Single Zener diodes in a SOD123F package

12. Revision history

| Table 12. Revision h | nistory | | | | | |
|----------------------|--|--------------------|---------------|----------------|--|--|
| Document ID | Release date | Data sheet status | Change notice | Supersedes | | |
| BZT52H_SER v.3 | 20101207 | Product data sheet | - | BZT52H_SER v.2 | | |
| Modifications: | Added selection B. | | | | | |
| | <u>Section 1.2 "Features and benefits"</u>: amended. | | | | | |
| | <u>Table 2 "Pinning"</u>: graphic symbol updated. | | | | | |
| | <u>Section 8 "Test information"</u>: added. | | | | | |
| | <u>Section 13 "Legal information"</u>: updated. | | | | | |
| BZT52H_SER v.2 | 20091115 | Product data sheet | - | BZT52H_SER v.1 | | |
| BZT52H_SER v.1 | 20051222 | Product data sheet | - | - | | |
| | | | | | | |

Single Zener diodes in a SOD123F package

13. Legal information

13.1 Data sheet status

| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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13.4 Trademarks

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Quick reference data — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

14. Contact information

For more information, please visit: http://www.nxp.com

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Single Zener diodes in a SOD123F package

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